

N-Channel Enhancement Mode MOSFET

HM3426B

DESCRIPTION

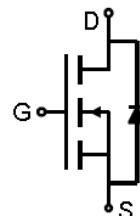
The HM3426B uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

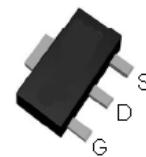
- RDS(ON) < 16mΩ @ VGS=4.5V
- RDS(ON) < 10mΩ @ VGS=10V
- High Power and current handling capability
- Lead free product is available
- Surface Mount Package

Application

- PWM applications
- Load switch
- Power management



Schematic diagram



Top View SOT-89

ABSOLUTE MAXIMUM RATINGS($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Diode Continuous Forward Current	$I_S(T_c=25^\circ\text{C})$	5	A
Continuous Drain Current (Note 1)	$I_D(T_c=25^\circ\text{C})$	18	A
Pulse Drain Current Tested	$I_{DM}(T_A=25^\circ\text{C})$	36	A
Maximum Power Dissipation	$P_D(T_c=25^\circ\text{C})$	20	W
Maximum Power Dissipation	$P_D(T_A=25^\circ\text{C})$	3.5	W
	$P_D(T_A=70^\circ\text{C})$	2.2	W
Thermal Resistance,Junction-to-Ambient($t<10\text{s}$)	$R_{\theta JA}$	35	$^\circ\text{C}/\text{W}$
Maximum Operating Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 To 150	$^\circ\text{C}$

NOTES:

1. Max continuous current is limited by bonding wire.

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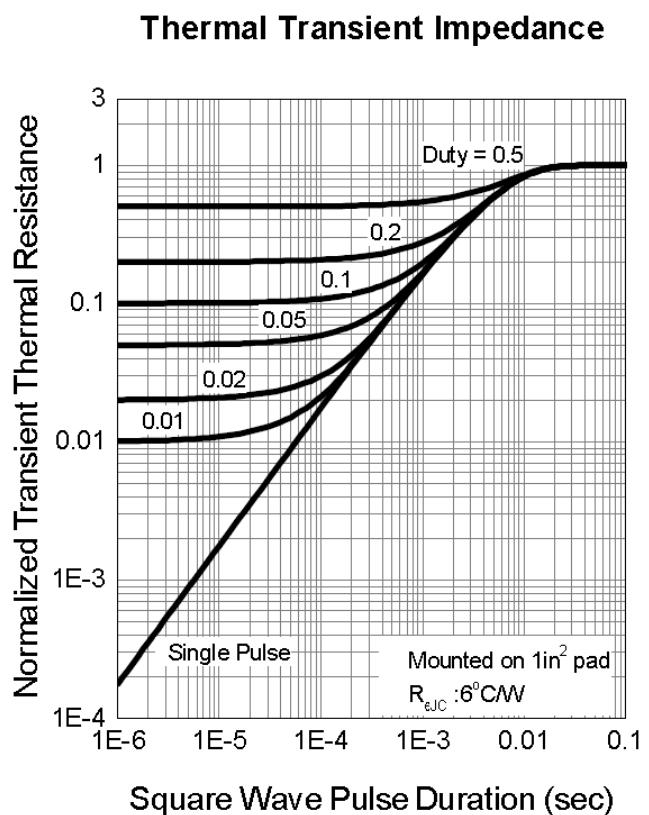
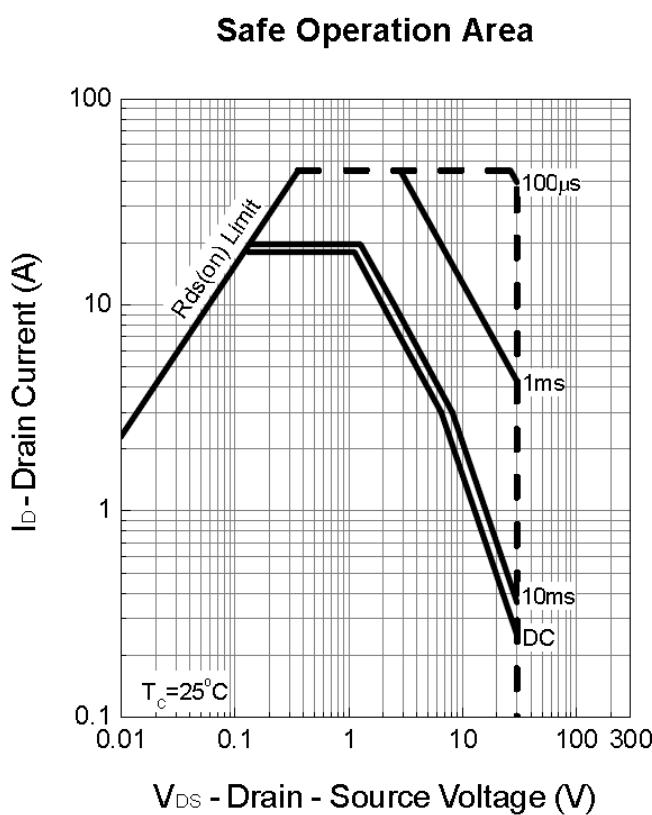
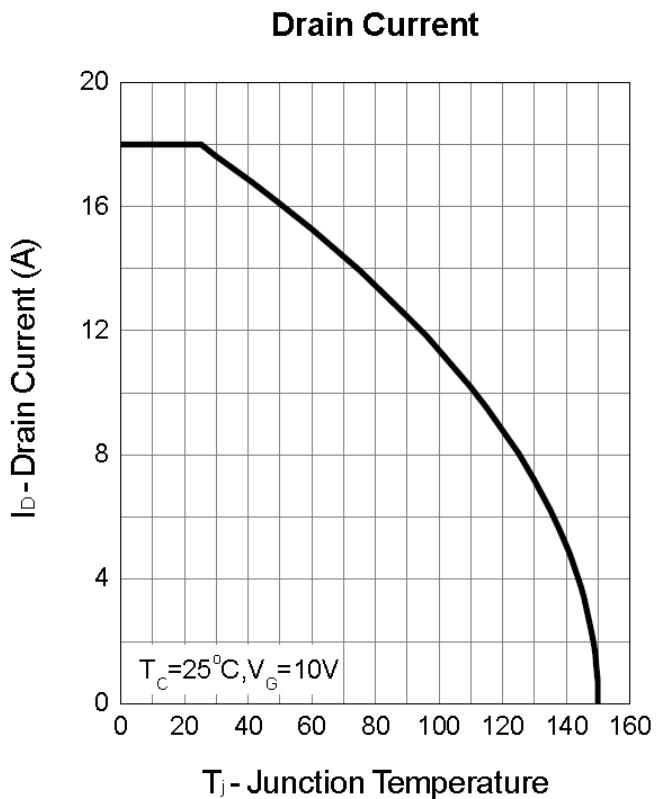
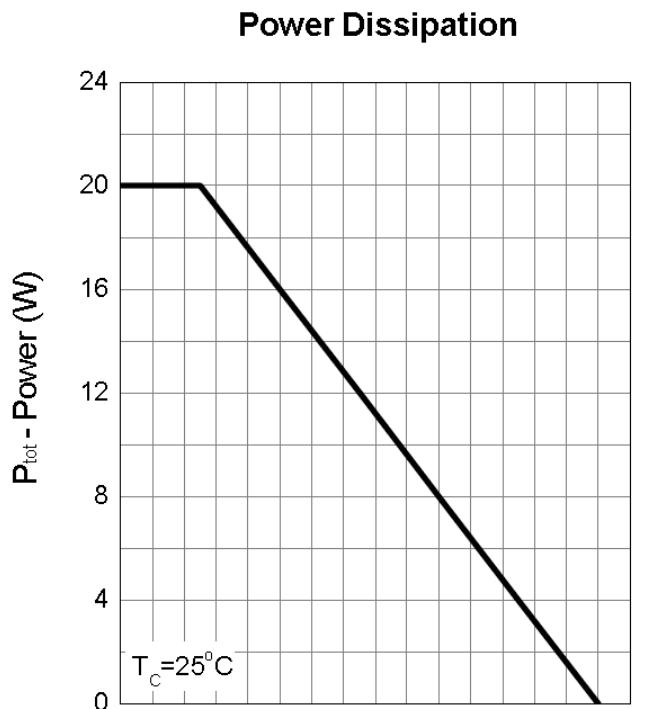
ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=24\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	± 10	μA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250\mu\text{A}$	1.4	1.8	2.5	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$	-	8.2	10	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=8\text{A}$	-	12.3	16	$\text{m}\Omega$
DYNAMIC CHARACTERISTICS (Note 3)						
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=15\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1.0\text{MHz}$	-	450	600	PF
Output Capacitance	C_{oss}		-	318	-	PF
Reverse Transfer Capacitance	C_{rss}		-	22	-	PF
SWITCHING CHARACTERISTICS (Note 3)						
Turn-on Delay Time	$\text{t}_{\text{d(on)}}$	$\text{V}_{\text{DS}}=15\text{V}, \text{R}_L=15\Omega, \text{V}_{\text{GEN}}=10\text{V}, \text{R}_G=6\Omega, \text{I}_D=1\text{A}$	-	8.5	16	nS
Turn-on Rise Time	t_r		-	10	18	nS
Turn-Off Delay Time	$\text{t}_{\text{d(off)}}$		-	14	26	nS
Turn-Off Fall Time	t_f		-	10.6	19	nS
Total Gate Charge	Q_g	$\text{V}_{\text{DS}}=15\text{V}, \text{I}_D=10\text{A}, \text{V}_{\text{GS}}=10\text{V}$	-	8	12	nC
Gate-Source Charge	Q_{gs}		-	1.6	-	nC
Gate-Drain Charge	Q_{gd}		-	1.2	-	nC
Body Diode Reverse Recovery Time	T_{rr}	$\text{I}_{\text{DS}}=10\text{A}, \frac{\text{dI}}{\text{dt}}=100\text{A}/\mu\text{s}$	-	20.5	-	nS
Body Diode Reverse Recovery Charge	Q_{rr}		-	7.2	-	nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 2)	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=5\text{A}$	-	0.8	1.1	V

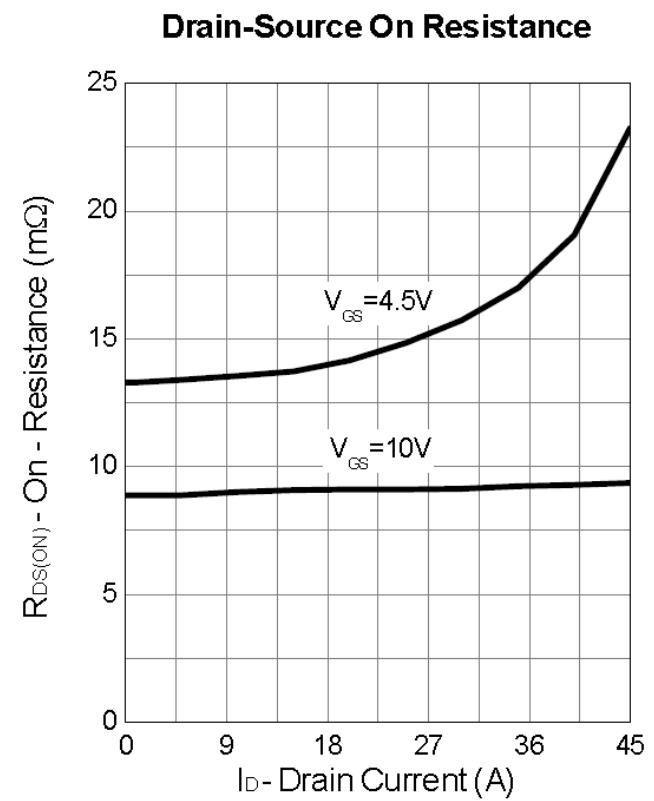
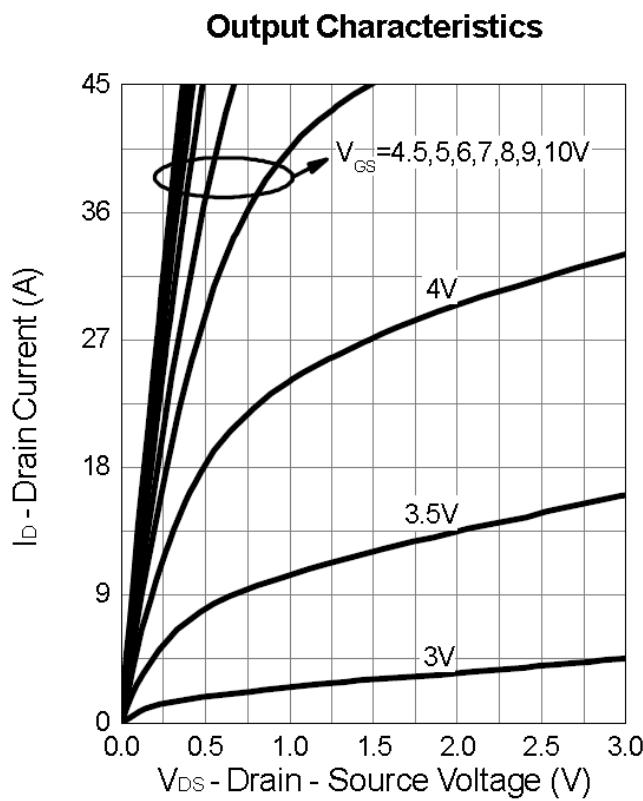
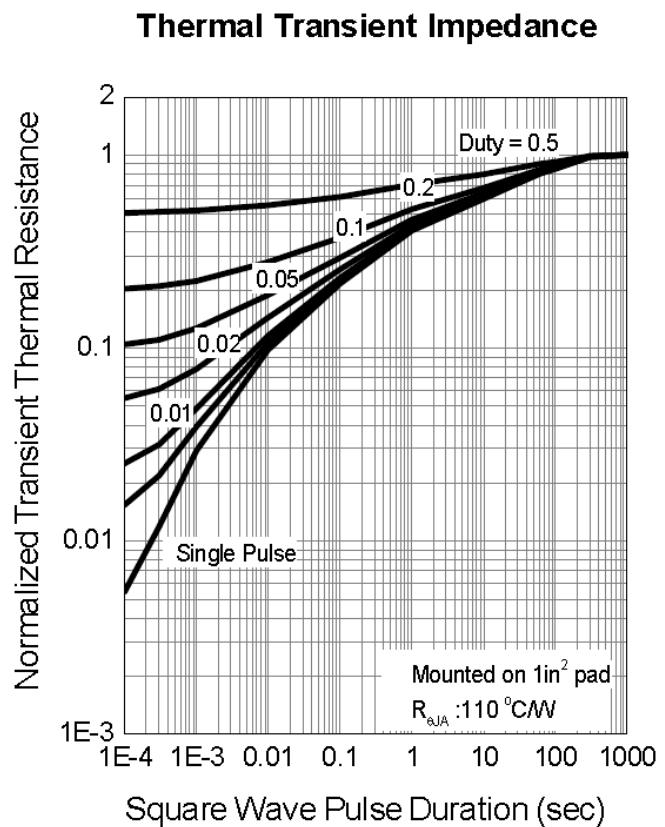
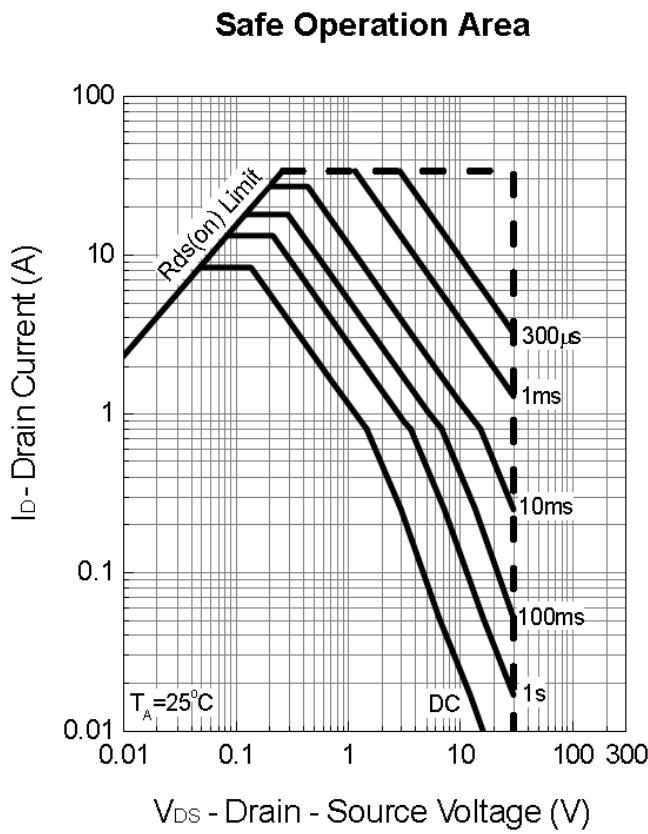
NOTES:

2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing

Typical Operating Characteristics

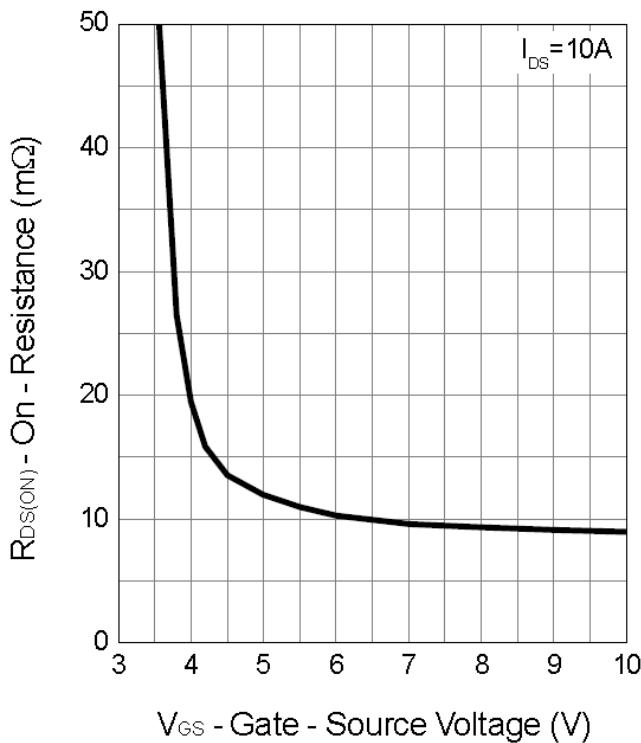


Typical Operating Characteristics(Cont.)

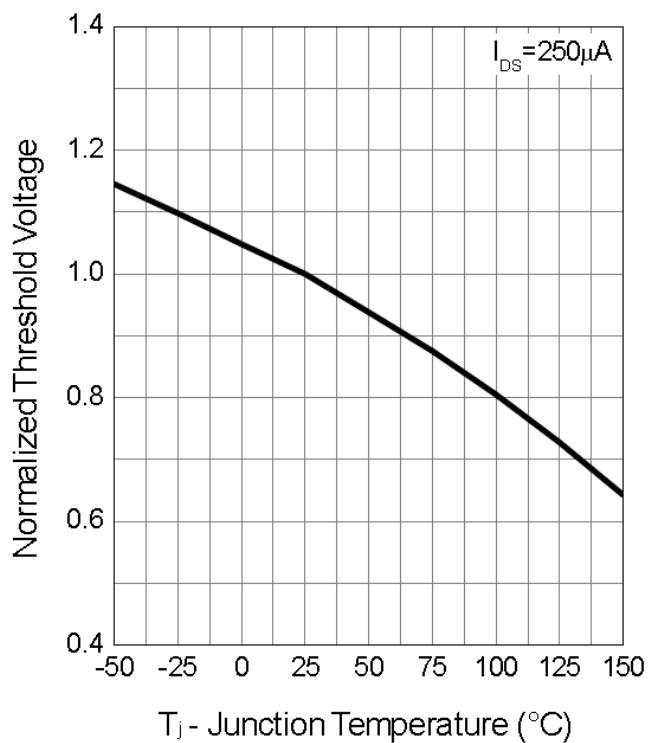


Typical Operating Characteristics (Cont.)

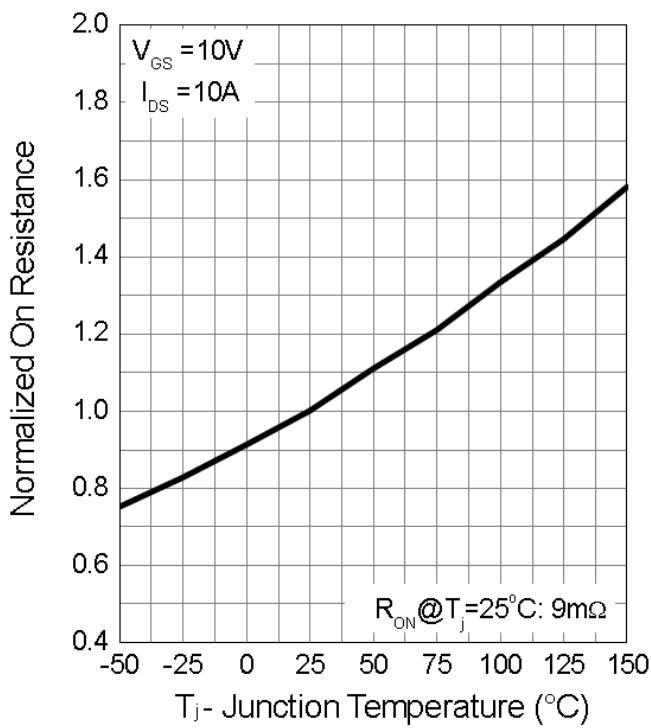
Gate-Source On Resistance



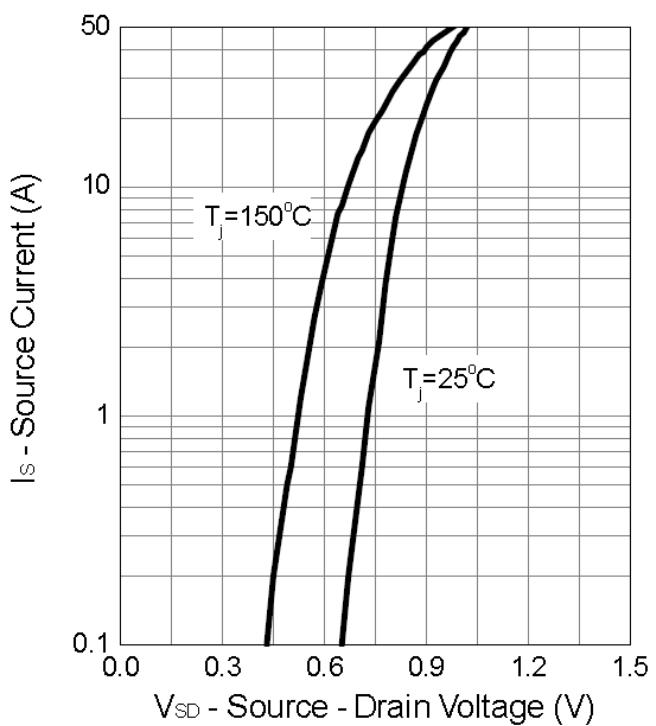
Gate Threshold Voltage



Drain-Source On Resistance

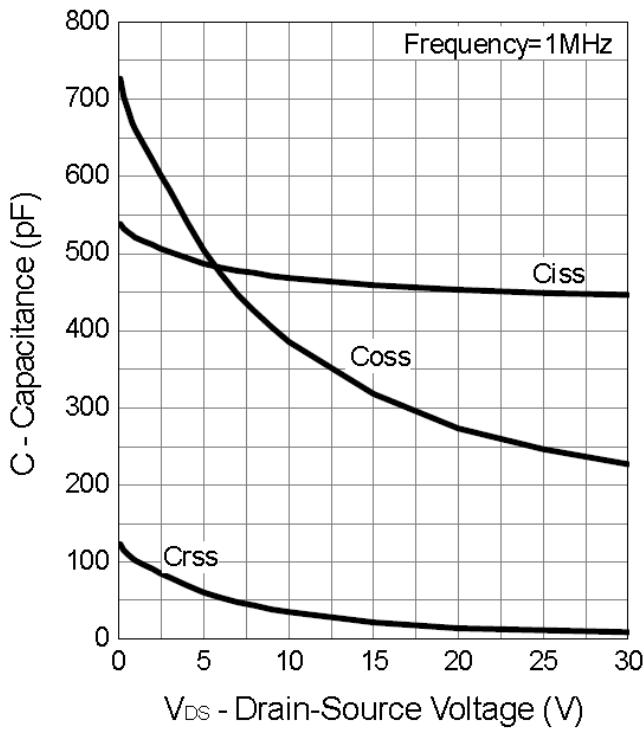


Source-Drain Diode Forward

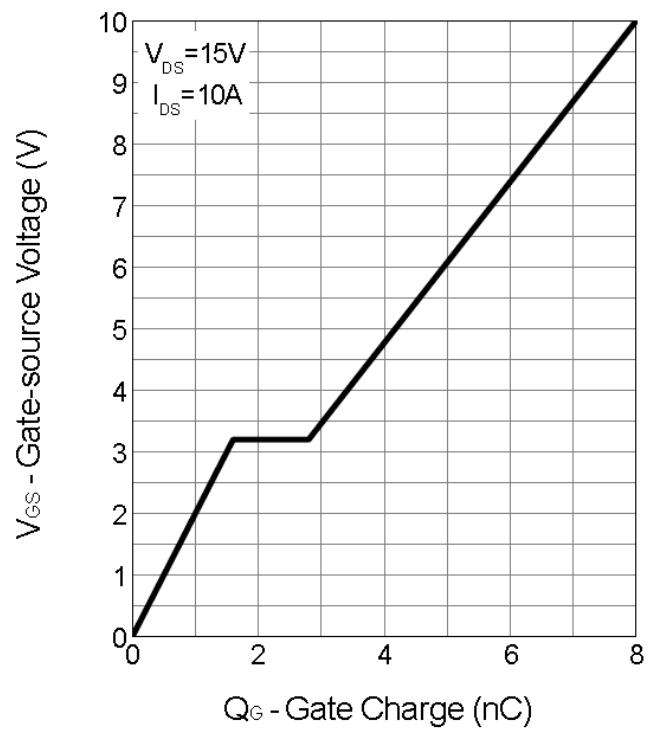


Typical Operating Characteristics (Cont.)

Capacitance

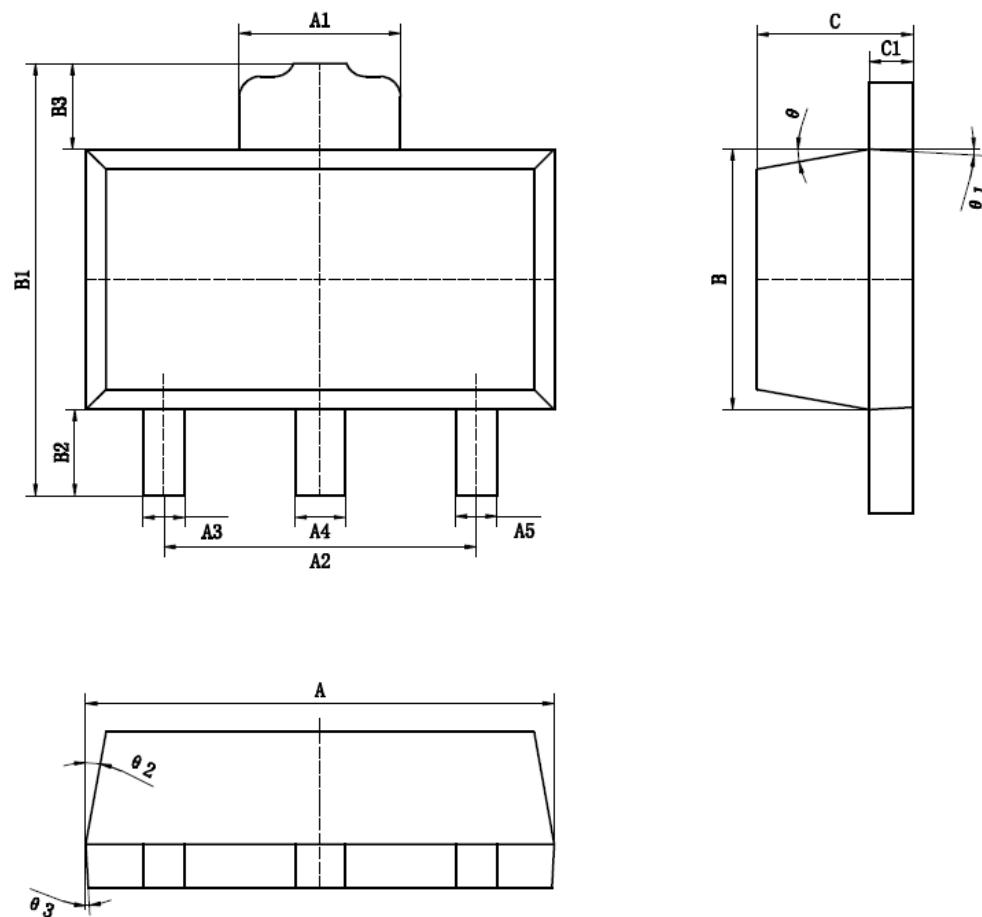


Gate Charge



Package Information

SOT89-3 Package



标注	尺寸	最小(mm)	最大(mm)	标注	尺寸	最小(mm)	最大(mm)
A	4.40	4.60		B3		0.82	0.83
A1	1.65	1.75		C		1.40	1.60
A2	2.95	3.05		C1		0.35	0.45
A3	0.35	0.45		θ		6° TYP4	
A4	0.43	0.53		θ1		3° TYP4	
A5	0.35	0.45		θ2		6° TYP4	
B	2.40	2.60		θ3		3° TYP4	
B1	4.05	4.25					
B2	0.82	0.83					